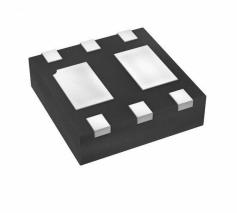


# DMC1030UFDB-13 Datasheet

www.digi-electronics.com



https://www.DiGi-Electronics.com

DiGi Electronics Part Number DMC1030UFDB-13-DG

Manufacturer Diodes Incorporated

Manufacturer Product Number DMC1030UFDB-13

Description MOSFET N/P-CH 12V 5.1A 6UDFN

Detailed Description Mosfet Array 12V 5.1A (Ta), 3.9A (Ta) 1.36W (Ta) Su

rface Mount U-DFN2020-6 (Type B)



Tel: +00 852-30501935

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# **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
DMC1030UFDB-13	Diodes Incorporated
Series:	Product Status:
	Active
Technology:	Configuration:
MOSFET (Metal Oxide)	N and P-Channel Complementary
FET Feature:	Drain to Source Voltage (Vdss):
	12V
Current - Continuous Drain (Id) @ 25°C:	Rds On (Max) @ ld, Vgs:
5.1A (Ta), 3.9A (Ta)	34mOhm @ 4.6A, 4.5V, 59mOhm @ 3.6A, 4.5V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
1V @ 250μA	12.2nC @ 4.5V, 13nC @ 4.5V
Input Capacitance (Ciss) (Max) @ Vds:	Power - Max:
1003pF @ 6V, 1028pF @ 6V	1.36W (Ta)
Operating Temperature:	Grade:
-55°C ~ 150°C (TJ)	Automotive
Qualification:	Mounting Type:
AEC-Q101	Surface Mount
Package / Case:	Supplier Device Package:
6-UDFN Exposed Pad	U-DFN2020-6 (Type B)
Base Product Number:	
DMC1030	

# **Environmental & Export classification**

8541.29.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	





#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

#### **Product Summary**

Device	BV <sub>DSS</sub>	RDS(ON) max	ID MAX TA = +25°C
		$34m\Omega$ @ V <sub>GS</sub> = 4.5V	5.1A
Q1	12\/	40mΩ @ V <sub>GS</sub> = 2.5V	4.7A
N-Channel	12V	50mΩ @ V <sub>GS</sub> = 1.8V	4.2A
		70mΩ @ V <sub>GS</sub> = 1.5V	3.6A
		59mΩ @ V <sub>GS</sub> = -4.5V	-3.9A
Q2	-12V	81mΩ @ V <sub>GS</sub> = -2.5V	-3.3A
P-Channel	-12V	115mΩ @ V <sub>GS</sub> = -1.8V	-2.8A
		215mΩ @ V <sub>GS</sub> = -1.5V	-2.0A

#### **Description**

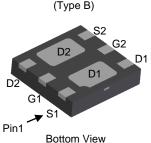
This MOSFET has been designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

#### **Applications**

- Load Switch
- Power Management Functions
- Portable Power Adaptors

#### U-DFN2020-6 (Type B)





#### **Features**

- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Max Height
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

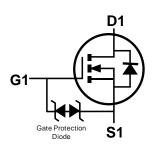
 This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

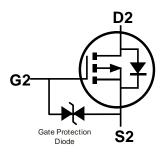
https://www.diodes.com/quality/product-definitions/

 An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMC1030UFDBQ</u>)

#### **Mechanical Data**

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202. Method 208@4)
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)





N-CHANNEL MOSFET

P-CHANNEL MOSFET

Internal Schematic

# Ordering Information (Note 4)

Part Number	Case	Packaging
DMC1030UFDB -7	U-DFN2020-6 (Type B)	3000/Tape & Reel
DMC1030UFDB -13	U-DFN2020-6 (Type B)	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



# **Marking Information**

Site 1



D3 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Date Code Rey												
Year	2014		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	В		Н		J	K	L	М	N	0	Р	R
	-											_
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Site 2



D3 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 0 = 2020) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Kev

Year	2014		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	4		0	1	2	3	4	5	6	7	8	9
Week	1-26			27	27-52			53				
Code		Α	-Z		a-z			a-z z			Z	
Internal Code	Sur	1	Mon		Tue	W	ed	Thu		Fri		Sat
Code	Т		U		V	V	٧	Х		Υ		Z



#### **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Unit		
Drain-Source Voltage			VDSS	12	-12	V
Gate-Source Voltage			Vgss	±8	±8	V
Continuous Drain Current (Note 5) N-Channel: Vgs = 4.5V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	lD	5.1 4.1	-3.9 -3.1	А
P-Channel: V <sub>G</sub> S = 4.5V	t < 5s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	lD	6.6 5.3	-5.0 -4.0	А
Maximum Continuous Body Diode Forward Curi	Is	2	-1.7	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle =	: 1%)		I <sub>DM</sub>	35	-25	Α

# **Thermal Characteristics**

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	Steady State	Pp	1.36	W	
Total Tower Dissipation (Note 3)	t < 5s	Pυ	1.89	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D- · ·	92		
Thermal Resistance, Junction to Ambient (Note 3)	t < 5s	R <sub>θ</sub> JA	66	°C/W	
Thermal Resistance, Junction to Case (Note 5)		R <sub>θ</sub> JC	18		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

# Electrical Characteristics Q1 N-CHANNEL (@ TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)	•			•	•	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	12	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS	_	_	1.0	μA	V <sub>DS</sub> = 12V, V <sub>GS</sub> = 0V
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	Vgs(th)	0.4	1	1	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
		_	17	34		$V_{GS} = 4.5V, I_{D} = 4.6A$
Static Drain-Source On-Resistance	Process	_	20	40	mΩ	$V_{GS} = 2.5V, I_{D} = 4.2A$
Static Dialit-Source Off-Nesistance	RDS(ON)	_	24	50	11122	$V_{GS} = 1.8V, I_D = 3.8A$
		_	28	70		V <sub>GS</sub> = 1.5V, I <sub>D</sub> = 1.5A
Diode Forward Voltage	VsD	_	0.7	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 4.8A
DYNAMIC CHARACTERISTICS (Note 7)	•			•	•	
Input Capacitance	Ciss		1003	_	pF	\\ C\\ \\ C\\
Output Capacitance	Coss	_	132	_	pF	V <sub>DS</sub> = 6V, V <sub>GS</sub> = 0V, -f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	115	_	pF	1 - 1.000112
Gate Resistance	Rg	_	11.3	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	0	_	12.2	_	nC	
Total Gate Charge (V <sub>GS</sub> = 8V)	Qg	_	23.1	_	nC	\/ 10\/ I- 6.8A
Gate-Source Charge	Qgs	_	1.3	_	nC	$V_{DS} = 10V, I_{D} = 6.8A$
Gate-Drain Charge	$Q_{gd}$	_	1.5	_	nC	
Turn-On Delay Time	td(on)	_	4.4	_	ns	
Turn-On Rise Time	t <sub>R</sub>	_	7.4	_	ns	V <sub>DD</sub> = 6V, V <sub>GS</sub> = 4.5V,
Turn-Off Delay Time	tD(OFF)		18.8	_	ns	$R_L = 1.1\Omega$ , $R_G = 1\Omega$
Turn-Off Fall Time	tF	_	4.9	_	ns	1
Body Diode Reverse Recovery Time	trr	_	7.6	_	ns	Is = 5.4A, dl/dt = 100A/µs
Body Diode Reverse Recovery Charge	Qrr		0.9		nC	Is = 5.4A, dl/dt = 100A/µs

Notes:

- 5. Device mounted on 1" × 1" FR-4 PCB with high coverage 2oz. Copper, single sided.
  6. Short duration pulse test used to minimize self-heating effect.
  7. Guaranteed by design. Not subject to product testing.



25°C

 $T_{A}' = 150^{\circ}C$ 

 $T_A = 85^{\circ}C$ 

T<sub>A</sub> = -55°C

16 18

 $V_{GS} = 2.5V$  $I_{D} = 5.0A$ 

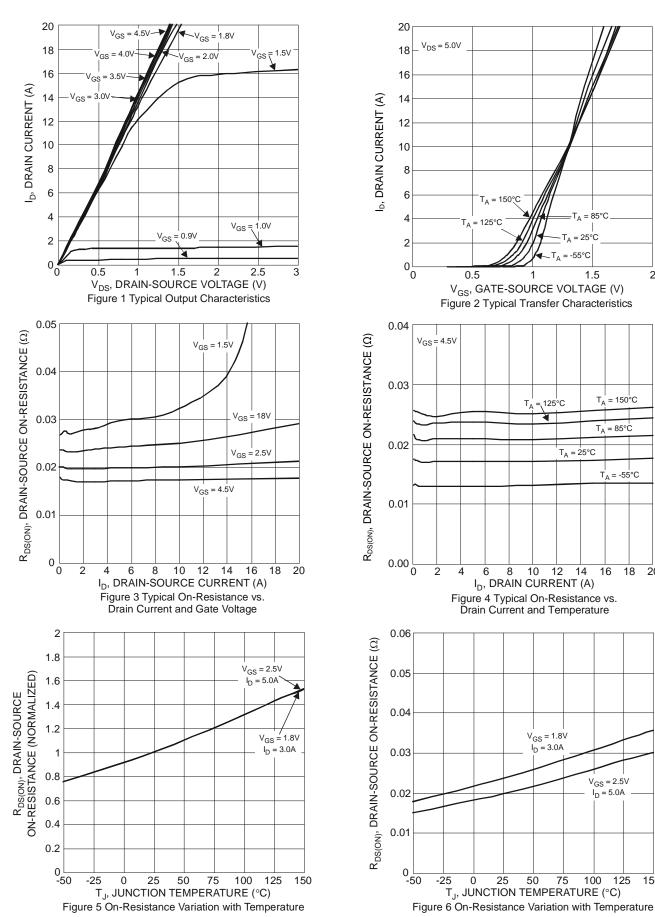
75

100

125

20

 $T_A = 25^{\circ}C$ 





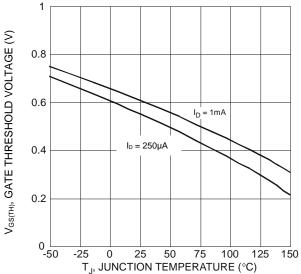
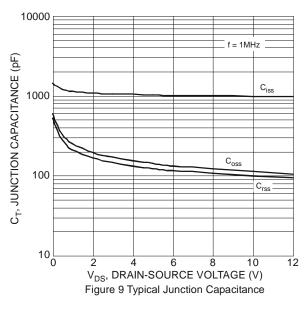
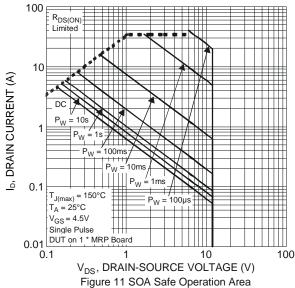
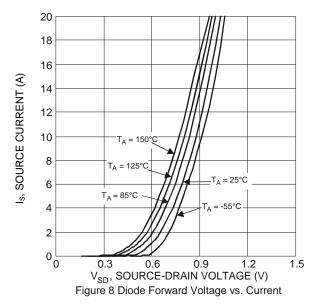
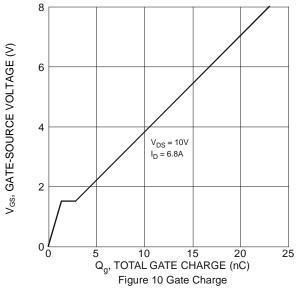


Figure 7 Gate Threshold Variation vs. Junction Temperature







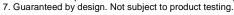


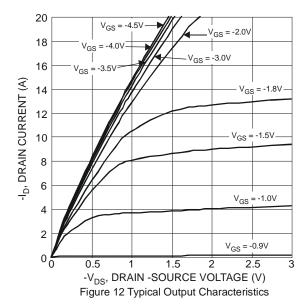


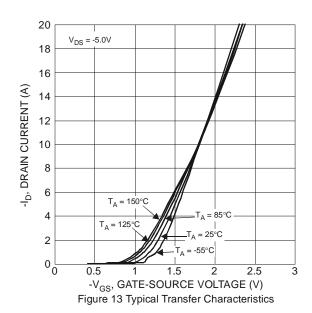
# Electrical Characteristics Q2 P-CHANNEL (@ TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-12	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS	_	_	-1.0	μA	V <sub>DS</sub> = -12V, V <sub>GS</sub> = 0V
Gate-Source Leakage	Igss	_	_	±10	μA	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)				•		
Gate Threshold Voltage	Vgs(TH)	-0.4	1	-1	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$
		_	37	59		Vgs = -4.5V, ID = -3.6A
Static Drain-Source On-Resistance	Process	_	48	81	mΩ	Vgs = -2.5V, ID = -3.1A
Static Drain-Source On-Nesistance	RDS(ON)	_	69	115	11122	$V_{GS} = -1.8V, I_D = -2.6A$
		_	88	215		$V_{GS} = -1.5V, I_D = -0.5A$
Diode Forward Voltage	VsD	_	-0.7	-1.2	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = -3.7A
DYNAMIC CHARACTERISTICS (Note 7)				•		
Input Capacitance	C <sub>iss</sub>	_	1028	_	pF	.,
Output Capacitance	Coss	_	285	_	pF	V <sub>DS</sub> = -6V, V <sub>GS</sub> = 0V, -f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	254	_	pF	1 - 1.001112
Gate Resistance	Rg	_	19.6	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = -4.5V)	0	_	13	_	nC	
Total Gate Charge (V <sub>GS</sub> = -8V)	Qg	_	20.8	_	nC	\/ 40\/ I- 4.74
Gate-Source Charge	Qgs	_	1.8	_	nC	$V_{DS} = -10V, I_{D} = -4.7A$
Gate-Drain Charge	$Q_{gd}$	_	4.5	_	nC	7
Turn-On Delay Time	tD(ON)	_	5.6	_	ns	
Turn-On Rise Time	t <sub>R</sub>	_	12.8	_	ns	V <sub>DD</sub> = -6V, V <sub>GS</sub> = -4.5V,
Turn-Off Delay Time	tD(OFF)	_	30.7	_	ns	$R_L = 1.6\Omega$ , $R_G = 1\Omega$
Turn-Off Fall Time	tF	_	25.4	_	ns	1
Body Diode Reverse Recovery Time	trr	_	31.6	_	ns	Is = -3.6A, dI/dt = 100A/µs
Body Diode Reverse Recovery Charge	Qrr	_	7.8	_	nC	$Is = -3.6A$ , $dI/dt = 100A/\mu s$

Notes: 6. Short duration pulse test used to minimize self-heating effect.



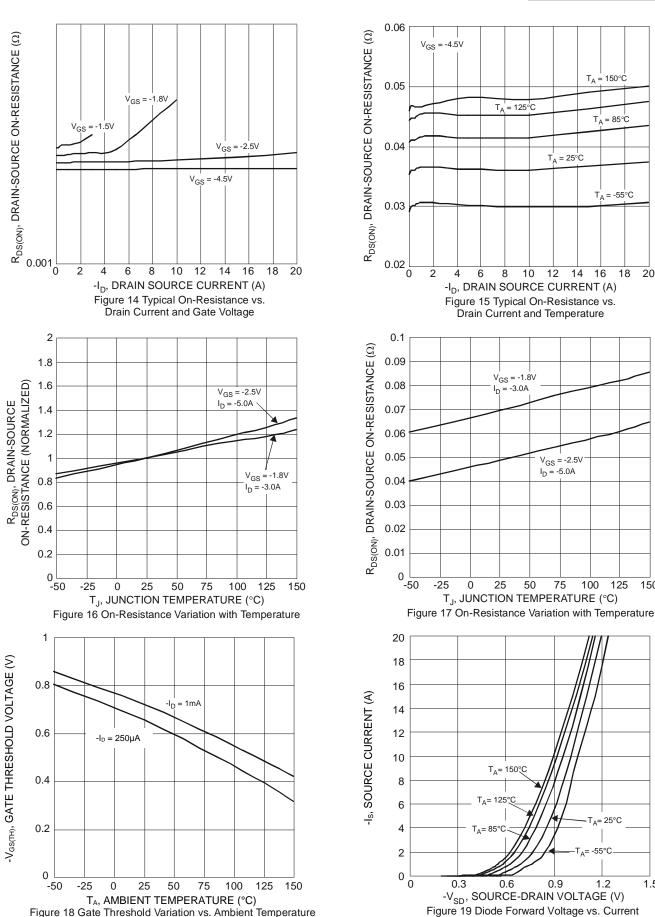






 $T_A = -55^{\circ}C$ 

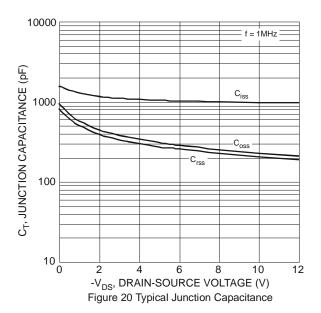
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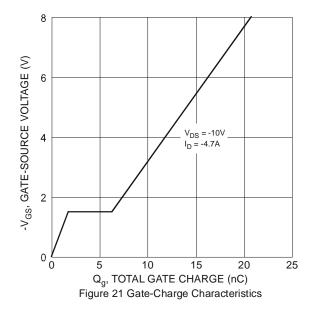


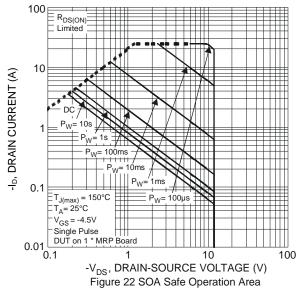
1.5

1.2











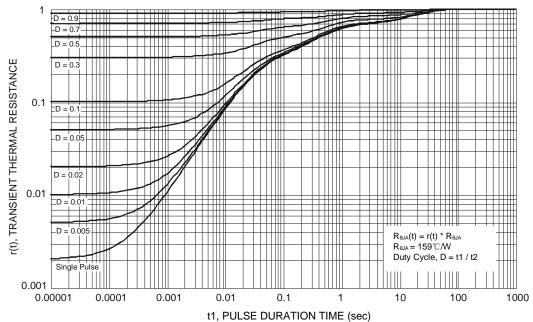


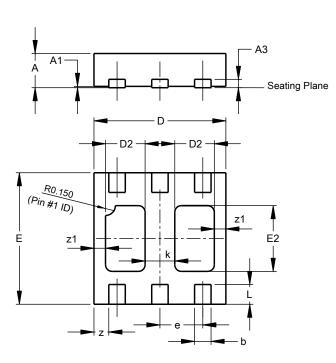
Figure 23 Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN2020-6 (Type B)

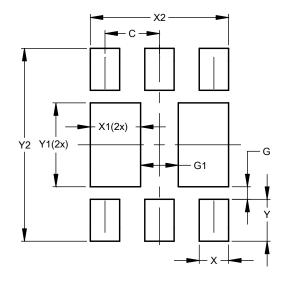


	U-DFN2020-6									
	Type B									
Dim	Min	Min Max Typ								
Α	0.545	0.605	0.575							
A1	0.00	0.05	0.02							
A3	-	-	0.13							
b	0.20	0.30	0.25							
D	1.95	2.075	2.00							
D2	0.50	0.70	0.60							
е	-	-	0.65							
Е	1.95	2.075	2.00							
E2	0.90	1.10	1.00							
k	-	-	0.45							
L	0.25	0.35	0.30							
Z	-	-	0.225							
z1	-	-	0.175							
All	Dimens	ions in	mm							

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN2020-6 (Type B)



Dimensions	Value (in mm)
С	0.650
G	0.150
G1	0.450
Х	0.350
X1	0.600
X2	1.650
Υ	0.500
Y1	1.000
Y2	2 300



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  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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